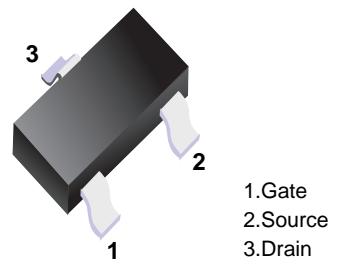


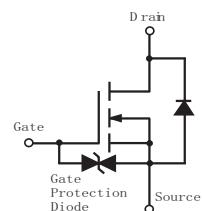
## ■ N-Channel Enhancement MOSFET

### ■ Features

- Low On-Resistance:  $R_{DS(ON)}$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected 2KV HBM



■ Simplified outline(SOT-323)



### ■ Absolute Maximum Ratings $T_a=25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage -Continuous	$V_{GS}$	$\pm 20$	
Drain Current -Continuous ( Note:1) -Pulsed	$I_D$	300	mA
		800	
Power Dissipation (Note 1)	$P_D$	350	mW
Thermal Resistance.Junction- to-Ambient	$R_{thJA}$	357	$^\circ\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Junction and Storage Temperature Range	$T_{stg}$	-55 to 150	

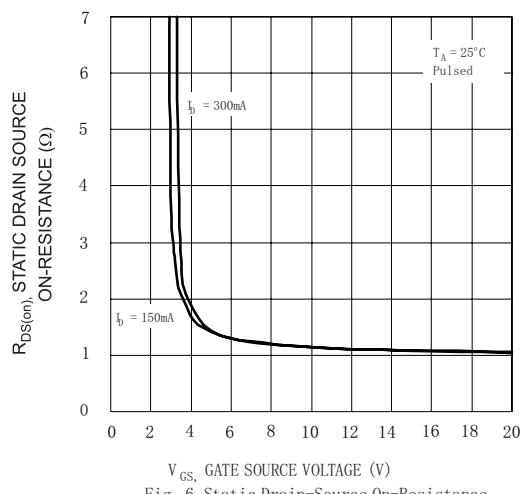
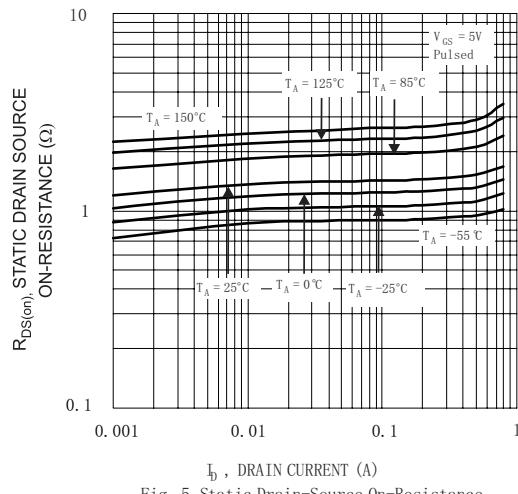
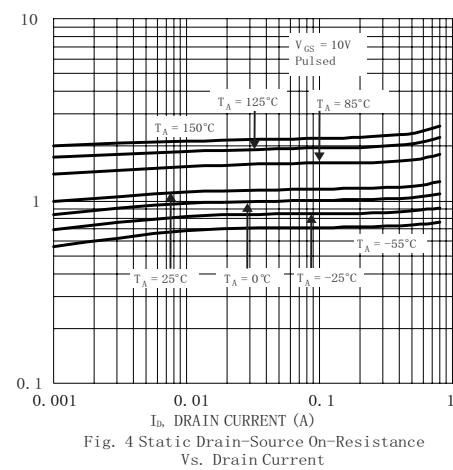
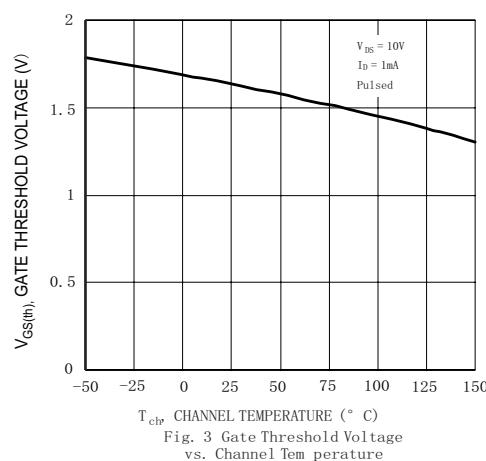
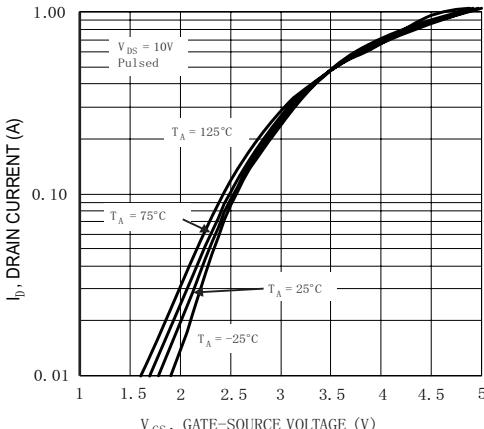
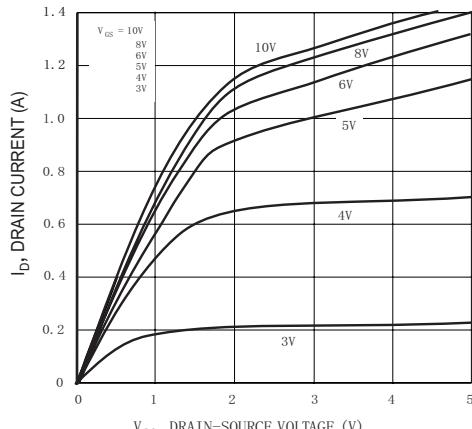
Notes: 1. Device mounted on FR-4 PCB.

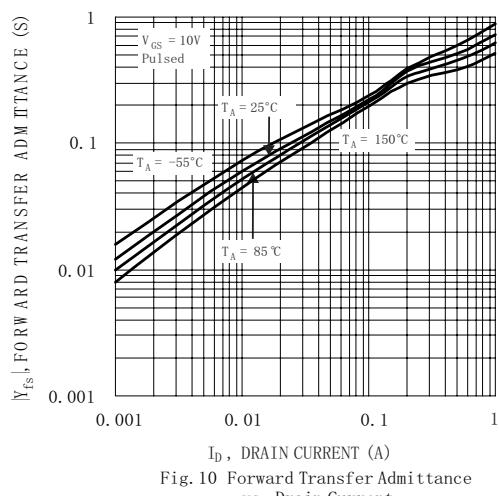
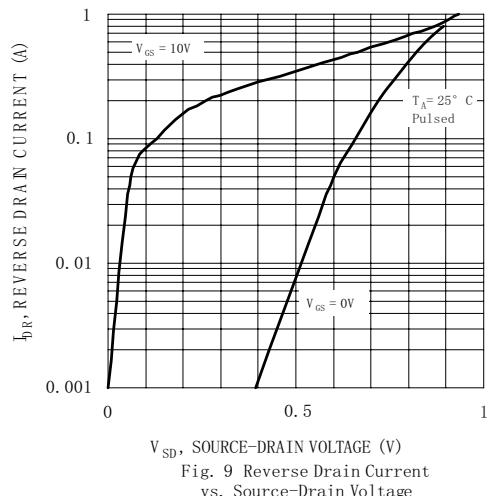
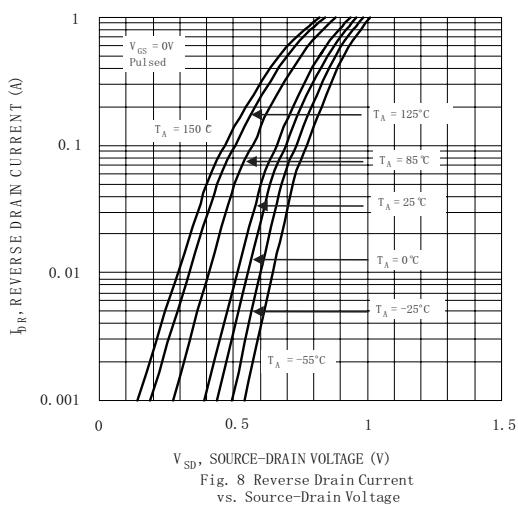
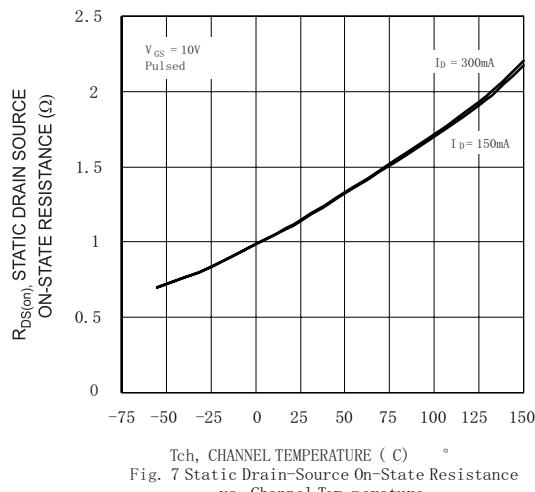
### ■ Electrical Characteristics $T_a = 25^\circ\text{C}$

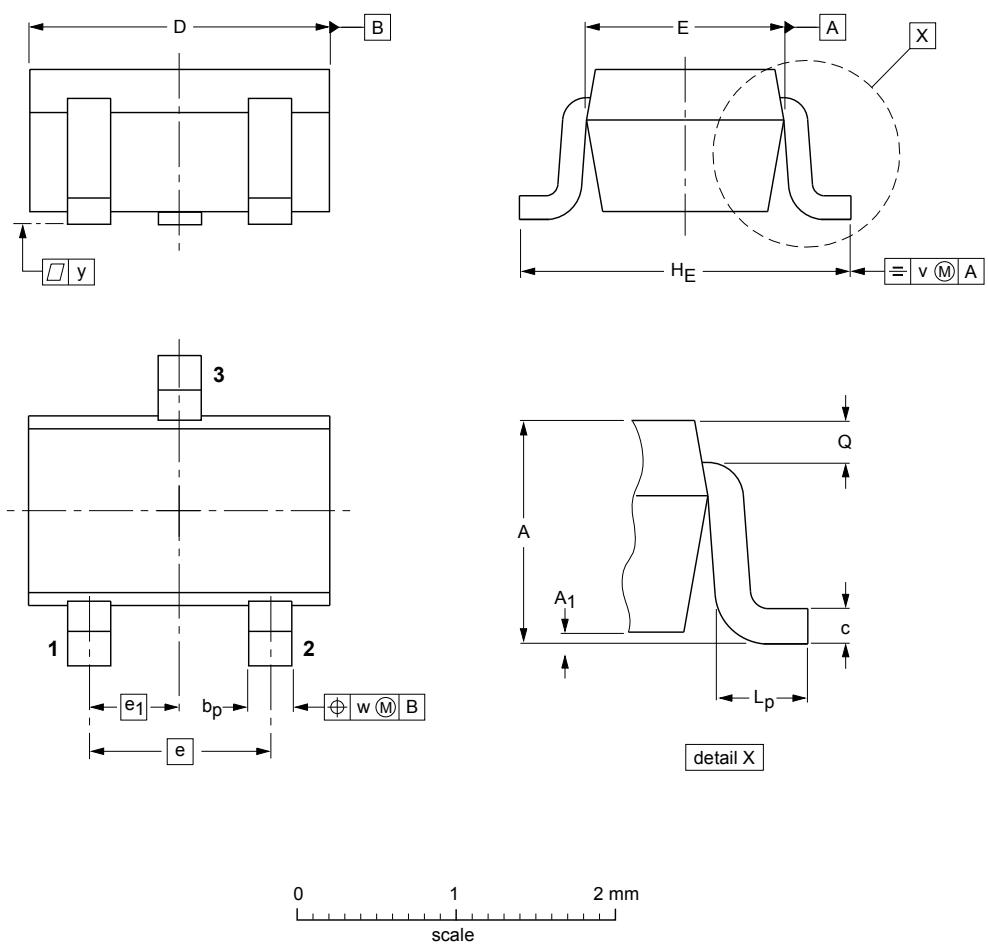
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage (Note.2)	$V_{DSS}$	$I_D=100 \mu\text{A}, V_{GS}=0\text{V}$	60			V
Zero Gate Voltage Drain Current (Note.2)	$I_{DSS}$	$V_{DS}=60\text{V}, V_{GS}=0\text{V}$			1	$\mu\text{A}$
Gate-Body Leakage Current (Note.2)	$I_{GSS}$	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 10$	$\mu\text{A}$
Gate Threshold Voltage (Note.2)	$V_{GS(th)}$	$V_{DS} = 10\text{V}, I_D = 1\text{mA}$	1	1.6	2.5	V
Static Drain-Source On-Resistance (Note.2)	$R_{DS(on)}$	$V_{GS}=10\text{V}, I_D=500\text{mA}$			2	$\Omega$
		$V_{GS}=10\text{V}, I_D=50\text{mA}$			3	
Forward Transfer Admittance (Note.2)	$ Y_{fs} $	$V_{GS}=10\text{V}, I_D=200\text{mA}$	80			ms
Input Capacitance	$C_{iss}$	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$			50	pF
Output Capacitance	$C_{oss}$				25	
Reverse Transfer Capacitance	$C_{rss}$				5	
Total Gate Charge	$Q_g$	$V_{GS}=4.5\text{V}, V_{DS}=15\text{V}, I_D=200\text{mA}$			0.8	nC
Turn-On DelayTime	$t_{d(on)}$	$I_D=200\text{mA}, V_{DS}=30\text{V}, R_G=10\Omega, V_{GEN}=10\text{V}, R_L=150\Omega$			20	ns
Turn-Off DelayTime	$t_{d(off)}$				40	

Note: 2. Short duration test pulse used to minimize self-heating effect.

## ■ Typical Characteristics





**■ SOT-323**

**DIMENSIONS (mm are the original dimensions)**

UNIT	A	$A_1$ max	$b_p$	c	D	E	e	$e_1$	$H_E$	$L_p$	Q	v	w
mm	1.1 0.8	0.1	0.4 0.3	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.23 0.13	0.2	0.2